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**Symposia
ICCES'13 Seattle, USA**

List of Formally-Approved Symposia (more to be added ...)

Symposium in Honour of Professor Wen-Hwa Chen, on the Occasion of his receiving the ICCES Lifetime Achievement Medal

Modern Computational Mechanics and Experiments: from Nano to Macro

Prof. Chyanbin Hwu

National Cheng Kung University, (Chwu@mail.ncku.edu.tw)

Prof. Kuo-Ning Chiang

National Tsing Hua University & National Center for High- Performance Computing, Taiwan (knchiang@pme.nthu.edu.tw)

Prof. Jeng-Tzong Chen

National Taiwan Ocean University, Taiwan (jtchen@mail.ntou.edu.tw)

Prof. Kuang-Chong Wu

National Taiwan University, Taiwan (wukc@spring.iam.ntu.edu.tw)

Prof. Dein Shaw

National Tsing Hua University, Taiwan (dishaw@pme.nthu.edu.tw)

Prof. Hsien-Chie Cheng

Feng Chia University, Taiwan (hccheng@fcu.edu.tw)

Symposium in Honour of Professor Mich Nakagaki, on the Occasion of his receiving the ICCES Lifetime Achievement Medal

Dr. Bud Brust

Engineering Mechanics Corporation of Columbus, USA (bbrust@emc-sq.com)

Dr. Hiroshi Okada

Tokyo University of Science, Japan (hokada@rs.noda.tus.ac.jp)

Dr. Hidekazu Murakawa

Osaka University, Japan (murakawa@jwri.osaka-u.ac.jp)

Symposium in Honour of Professor Daniel Post, on the Occasion of his receiving the ICCES Lifetime Achievement Medal

Professor Bongtae Han

The University of Maryland, USA (bthan@umd.edu)

Professor Peter Ifju

University of Florida, USA (ifju@ufl.edu)

Symposium in Honour of Professor APS Selvadurai, on the Occasion of his receiving the ICCES Reissner Medal

Professor Nimal Rajapakse

Simon Fraser University, Canada (rajapaks@sfu.ca)

Application of Data Analysis

Professor Tahir Cetin Akinci

Kirklareli University, Turkey (cetinakinci@kirklareli.edu.tr)

Cell Method and Related Meshless Methods

Professor Elena Ferretti

Alma Mater Studiorum – University of Bologna, Italy (elena.ferretti2@unibo.it)

Computational Mechanics of Laminated and Functionally Plates and Shells

Professor Tarun Kant

Indian Institute of Technology, Bombay, India (tkant@iitb.ac.in)

Deformation and failure mechanics of heterogeneous materials

Dr. Pramada Valli and Mr. R.K.Panigrahi

National Informatics Centre, India (pramada.ccri@nic.in)

Development of Novel Smart Materials

Dr Xiaonan Hou

The Hong Kong Polytechnic University, China (xiaonan.hou@polyu.edu.hk)

Full-field Deformation Measurement Techniques

Dr. Huiqing Helena Jin

Sandia National Laboratories, USA (hjin@sandia.gov)

Growth or Dissolution in Fluid Flows

Dr. Hiromoto Susawa

Aichi, Japan (automobile_21@yahoo.co.jp)

Image Processing and Analysis

Professors João Manuel R. S. Tavares

*Faculdade de Engenharia da Universidade do Porto, PORTUGAL
(tavares@fe.up.pt)*

Professor Renato M. Natal Jorge

*Faculdade de Engenharia da Universidade do Porto, PORTUGAL
(rnatal@fe.up.pt)*

Professor Yongjie (Jessica) Zhang

Carnegie Mellon University, USA (jessicz@andrew.cmu.edu)

Low-dimensionanl Magnetic Nanomaterials

Professor Wenli Pei

Northeastern University, China (peiwl@smm.neu.edu.cn)

Material Processing and Manufacturing

Professor Mamidala Ramulu

University of Washington, USA (ramulum@u.washington.edu)

Metamaterials

Professor Rakesh Mohan Jha

CSIR-National Aerospace Laboratories, India (jha@nal.res.in)

MLPG, Trefftz, MFS, BEM & Other Novel Computational Methods

Prof. J. Sladek

Slovak Academy of sciences, Slovakia (sladek@savba.sk)

Prof. V. Sladek

Slovak Academy of sciences, Slovakia (vladimir.sladek@savba.sk)

Prof. S.N. Atluri

Univesity of California, Irvine, USA (snatluri@uci.edu)

Modeling of Mechanical Behaviour of Materials

Professor T. Jayakumar

Indira Gandhi Centre for Atomic Research, India (tjk@igcar.gov.in)

Multiphysics Modeling and its Applications



Dr. Xinpu Shen
Halliburton, USA (Xinpu.Shen@halliburton.com)

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